CHIP COIL (CHIP INDUCTORS) LQW18AN□□□□8ZD Murata Standard Reference Specification 【AEC-Q200】

1. Scope

This reference specification applies to LQW18AN_8ZD series, Chip coil (Chip Inductors) for automotive Electronics based on AEC-Q200 except for Power train and Safety.

2. Part Numbering

(ex)LQW18AN2N2C8ZDProduct IDStructureDimension (L×W)Applications and (L×W)Category Inductance Inductance

3. Rating

· Operating Temperature Range.

-55°C to +125°C (Rated Current is derated as following figure depending)

• Storage Temperature Range. -55°C to +125°C

		Ind	uctance		DC	Self	Rated	ESD					
Customer Part Number	MURATA Part Number	(nH)	Tolerance	Q (min.)	Resistance (Ω max.)	Resonant Frequency (MHz min.)	Current (mA)						
	LQW18AN2N2C8ZD	2.2		24	0.018		3200						
	LQW18AN2N4C8ZD	2.4	C:±0.2nH	18	0.026	15000	2400						
	LQW18AN3N0C8ZD	3.0		13	0.17		670						
	LQW18AN3N9B8ZD												
	LQW18AN3N9C8ZD	3.9											
	LQW18AN3N9G8ZD												
	LQW18AN4N1B8ZD												
	LQW18AN4N1C8ZD	4.1		30	0.028	10000	2200						
	LQW18AN4N1G8ZD												
	LQW18AN4N2B8ZD												
	LQW18AN4N2C8ZD	4.2											
	LQW18AN4N2G8ZD		B:±0.1nH C:±0.2nH G:±2%										
	LQW18AN4N3B8ZD												
	LQW18AN4N3C8ZD	4.7	4.3	4.3	.3	35	0.036	11600	2100				
	LQW18AN4N3G8ZD												
	LQW18AN4N7B8ZD												
	LQW18AN4N7C8ZD				25	0.054	10400	1500	6				
	LQW18AN4N7G8ZD			4.9	4.9								
	LQW18AN4N9B8ZD]	
	LQW18AN4N9C8ZD						23	0.081	7300	1200			
	LQW18AN4N9G8ZD												
	LQW18AN5N6C8ZD	5.6		38				1					
	LQW18AN5N6G8ZD	5.0		30									
	LQW18AN6N0C8ZD	6											
	LQW18AN6N0G8ZD	O											
	LQW18AN6N5C8ZD	G E		40	0.040	6650	1900						
	LQW18AN6N5G8ZD	6.5	C:±0.2nH	40	0.040	0000	1900						
	LQW18AN6N8C8ZD		G:±2%										
	LQW18AN6N8G8ZD	6.8											
	LQW18AN7N2C8ZD	7.2		38									
	LQW18AN7N2C8ZD	1.4		50									
	LQW18AN7N5C8ZD	7.5		35	0.048	7000	1500						
	LQW18AN7N5G8ZD	7.5		- 55	0.040	7000	1300						

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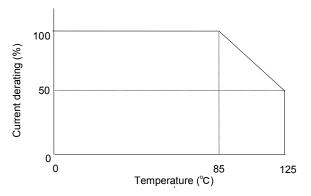
Customer	MURATA	Ind	uctance	Q	DC	Self Resonant	Rated	ESD											
Part Number	Part Number	(nH)	Tolerance	(min.)	Resistance (Ω max.)	Frequency (MHz min.)	Current (mA)	Rank 6: 25kV											
	LQW18AN8N2C8ZD	0.0				(141112 1111111)													
	LQW18AN8N2G8ZD	8.2																	
	LQW18AN8N4C8ZD	8.4																	
	LQW18AN8N4G8ZD	0.4																	
	LQW18AN8N7C8ZD	8.7																	
	LQW18AN8N7G8ZD	0.7	C:±0.2nH																
	LQW18AN9N1C8ZD	9.1	G:±2%	38															
	LQW18AN9N1G8ZD	5.1		00	0.052	4750	1600												
	LQW18AN9N5C8ZD	9.5			0.002	1700	1000												
	LQW18AN9N5G8ZD	0.0																	
	LQW18AN9N9C8ZD	9.9																	
	LQW18AN9N9G8ZD	0.0																	
	LQW18AN10NG8ZD	10																	
	LQW18AN10NJ8ZD																		
	LQW18AN11NG8ZD	11		40															
	LQW18AN11NJ8ZD																		
	LQW18AN12NG8ZD	12																	
	LQW18AN12NJ8ZD			37	0.064	5000	1500												
	LQW18AN13NG8ZD	13	13																
	LQW18AN13NJ8ZD		_					_											
	LQW18AN15NG8ZD	15		38															
	LQW18AN15NJ8ZD	16	16						6										
	LQW18AN16NG8ZD																		
	LQW18AN16NJ8ZD																		
	LQW18AN17NG8ZD	17			0.075	4600	1400												
	LQW18AN17NJ8ZD	18			18	- 18	18	-											
	LQW18AN18NG8ZD							18	18	18	18	18	18						
	LQW18AN18NJ8ZD													G:±2% J:±5%					
	LQW18AN19NG8ZD	19	J.±5 /6																
	LQW18AN19NJ8ZD																		
	LQW18AN22NG8ZD	22																	
	LQW18AN22NJ8ZD		-																
	LQW18AN23NG8ZD	23		40	0.086	3450	1300												
	LQW18AN23NJ8ZD		-																
	LQW18AN24NG8ZD	24																	
	LQW18AN24NJ8ZD		-																
	LQW18AN25NG8ZD	25																	
	LQW18AN25NJ8ZD LQW18AN27NG8ZD		-																
	LQW18AN27NG8ZD LQW18AN27NJ8ZD	27			0.098	3600	1200												
	LQW18AN27NJ8ZD LQW18AN28NG8ZD		-																
	LQW18AN28NJ8ZD	28																	
	LQW18AN30NG8ZD		-																
		30			0.12	2880	1100												
	LQW18AN30NJ8ZD				0.12														

Reference Only

		Ind	uctance		D.0	Self	5	505	
Customer Part Number	MURATA Part Number	(nH)	Tolerance	Q (min.)	DC Resistance (Ω max.)	Resonant Frequency (MHz min.)	Rated Current (mA)	ESD Rank 6: 25kV	
	LQW18AN31NG8ZD	31							
	LQW18AN31NJ8ZD	•			0.11	3150	1100		
	LQW18AN33NG8ZD	33		40					
	LQW18AN33NJ8ZD								
	LQW18AN34NG8ZD	34			0.15		1050		
	LQW18AN34NJ8ZD								
	LQW18AN36NG8ZD	36				3000			
	LQW18AN36NJ8ZD			37	0.20		910		
	LQW18AN37NG8ZD	37							
	LQW18AN37NJ8ZD								
	LQW18AN39NG8ZD	39							
	LQW18AN39NJ8ZD				0.16	3280	1000		
	LQW18AN41NG8ZD	41							
	LQW18AN41NJ8ZD LQW18AN43NG8ZD			40					
	LQW18AN43NJ8ZD	43							
	LQW18AN44NG8ZD				0.21	2780	840		
	LQW18AN44NJ8ZD	44							
	LQW18AN47NG8ZD		-					_	
	LQW18AN47NJ8ZD	47							
	LQW18AN48NG8ZD								
	LQW18AN48NJ8ZD	48	G:±2%	32	0.23	2700	830		
	LQW18AN51NG8ZD		J:±5%					6	
	LQW18AN51NJ8ZD	51 52 56							
	LQW18AN52NG8ZD								
	LQW18AN52NJ8ZD				35	0.27	2750	750	
	LQW18AN56NG8ZD								
	LQW18AN56NJ8ZD			38	0.26	2600	770		
	LQW18AN58NG8ZD								
	LQW18AN58NJ8ZD	58		35	0.30	2400	700		
	LQW18AN68NG8ZD	00							
	LQW18AN68NJ8ZD	68		27	0.00	2200	000		
	LQW18AN69NG8ZD			37	0.38	2380	630		
	LQW18AN69NJ8ZD	69							
	LQW18AN72NG8ZD	72		34	0.47	2330	560		
	LQW18AN72NJ8ZD	12		34	0.47	2330	560		
	LQW18AN73NG8ZD	73							
	LQW18AN73NJ8ZD	73							
	LQW18AN75NG8ZD	75		28	0.41	2280	590		
	LQW18AN75NJ8ZD	, ,		20	J.71	2200	550		
	LQW18AN78NG8ZD	78							
	LQW18AN78NJ8ZD	, 0							
	LQW18AN82NG8ZD	82		34	0.5	2230	550		
	LQW18AN82NJ8ZD				0.0		300		

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		Ind	uctance		DC	Self Resonant	Rated	ESD					
Customer Part Number	MURATA Part Number	(nH)	Tolerance	Q (min.)	Resistance (Ω max.)	Frequency (MHz min.)	Current (mA)	Rank 6: 25kV					
	LQW18AN83NG8ZD	83		34	0.5	2230	550						
	LQW18AN83NJ8ZD	03		34	0.5	2230	330						
	LQW18AN91NG8ZD	91		33	0.54	1900	520						
	LQW18AN91NJ8ZD	31		33	0.04	1300	320						
	LQW18AN94NG8ZD	94											
	LQW18AN94NJ8ZD	34		34	0.63	1750	490						
	LQW18ANR10G8ZD	100		34	0.03	1730	490						
	LQW18ANR10J8ZD	100											
	LQW18ANR11G8ZD	110			0.7	1730							
	LQW18ANR11J8ZD	110		32	0.7	1730	450						
	LQW18ANR12G8ZD	120		32	0.72	1650	450						
	LQW18ANR12J8ZD	120			0.72	1030							
	LQW18ANR15G8ZD	150		28	0.87	1580	420						
	LQW18ANR15J8ZD	180		130	100	150	150	150	20	0.07	1300	420	
	LQW18ANR18G8ZD					1.65	1380	310	1				
	LQW18ANR18J8ZD			25	1.00	1300	310						
	LQW18ANR20G8ZD		G:±2%	25	1.74	1350	290	6					
	LQW18ANR20J8ZD		J:±5%		1.74	1330	290	0					
	LQW18ANR21G8ZD		210		27	1.98							
	LQW18ANR21J8ZD			21	1.90		200						
	LQW18ANR22G8ZD			25	2.00	1220	280						
	LQW18ANR22J8ZD	220		25	2.08	1330							
	LQW18ANR25G8ZD	250			0.00		250						
	LQW18ANR25J8ZD	250		24	2.28		250						
	LQW18ANR27G8ZD	270		24	2.42	1050	260						
	LQW18ANR27J8ZD	270			2.42	1250	260						
	LQW18ANR30G8ZD	200	•		2.40	1200	220						
	LQW18ANR30J8ZD	300			3.12	1200	220						
	LQW18ANR33G8ZD	000			0.04	4400							
	LQW18ANR33J8ZD	330		25	3.84	1100							
	LQW18ANR36G8ZD	260		25	2.00	1050	100						
	LQW18ANR36J8ZD	360			3.98	1050	190						
	LQW18ANR39G8ZD	200			4.00	1100							
	LQW18ANR39J8ZD	390			4.23	1100							



Derating of Rated Current depend on Operating Temperature



4. Testing Conditions

《Unless otherwise specified》

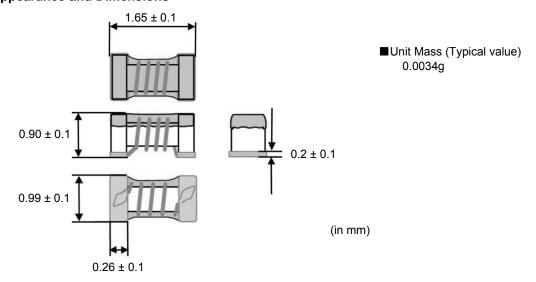
Temperature : Ordinary Temperature / 15°C to 35°C Humidity : Ordinary Humidity / 25%(RH) to 85%(RH)

《In case of doubt》

: 20°C±2°C Temperature

: 60%(RH) to 70%(RH) Humidity Atmospheric Pressure : 86kPa to 106 kPa

5. Appearance and Dimensions



6. Electrical Performance

Item	Specification	Test Method
Inductance	Inductance shall meet item 3.	Measuring Equipment: KEYSIGHT 4287A or equivalent Measuring Frequency: <inductance> 100MHz</inductance>
Q	Q shall meet item 3.	1608 Size Guide
		Measuring Method : See the endnote. <electrical :="" inductance="" measuring="" method="" of="" performance="" q=""></electrical>
DC Resistance	DC Resistance shall meet item 3.	Measuring Equipment : Digital multi meter
Self Resonant Frequency(S.R.F)	S.R.F shall meet item 3.	Measuring Equipment : KEYSIGHT N5230A or equivalent
Rated Current	Self temperature rise shall be limited to 40°C max.	The rated current is applied.
	Inductance Q DC Resistance Self Resonant Frequency(S.R.F)	Inductance Inductance shall meet item 3. Q Q shall meet item 3. DC Resistance DC Resistance shall meet item 3. Self Resonant Frequency(S.R.F) Rated Current Self temperature rise shall be



7. Q200 Requirement

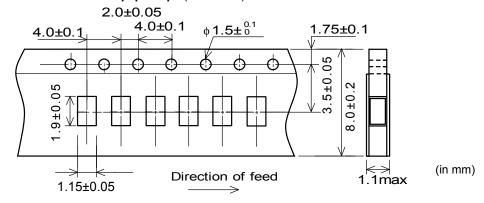
7.1.Performance (based on Table 5 for Magnetics(Inductors / Transformer) AEC-Q200 Rev.D issued June 1. 2010

		AEC-Q200			
No	Stress	Test Method	Murata Specification / Deviation		Deviation
3	High	1000hours at 125 deg C		A after testing.	
	Temperature Exposure	Set for 24hours at room temperature, then measured.	Table A	Appearance	No damage
	Lxposure	temperature, men measureu.		Inductance change (at 100MHz)	Within ±5%
4	Temperature Cycling	1000cycles -40 deg C to +125 deg C Set for 24hours at room temperature,then measured.	Meet Table	A after testing.	
7	Biased Humidity	1000hours at 85 deg C, 85%RH unpowered.	Meet Table A after testing.		
8	Operational Life	Apply Rated Current 125 deg C 1000hours Set for 24hours at room temperature, then measured	Meet Table A after testing.		
9	External Visual	Visual inspection	No abnormalities		
10	Physical Dimension	Meet ITEM 4 (Style and Dimensions)	No defects		
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable		
13	Mechanical Shock	Per MIL-STD-202 Method 213 Condition C : 100g's(0.98N), 6ms, Half sine, 12.3ft/s	Meet Table A after testing.		
14	Vibration	5g's(0.049N) for 20 minutes, 12cycles each of 3 orientations Test from 10-2000Hz.	Meet Table	A after testing.	
15	Resistance to Soldering Heat	No-heating Solder temperature 260C+/-5 deg C Immersion time 10s	Pre-heating : 150C +/-10 deg C, 60s to 90s Meet Table A after testing.		
17	ESD	Per AEC-Q200-002	ESD Rank : Refer to Item 3. Rating. Meet Table A after testing.		
18	Solderbility	Per J-STD-002	Method b : Not Applicable 95% of the terminations is to be soldered. (Except exposed wire)		
19	Electrical Characterization	Measured : Inductance	No defects		
20	Flammability	Per UL-94	Not Applicat		

	AEC-Q200			Murata Specification / Deviation			
No	Stress	Test Method	Murata Specification / Deviation				
21	Board Flex	Epoxy-PCB(1.6mm)		B after testing.	_		
		Deflection 2mm(min)	Holding time 60s	Table B	Appearance	No damage	
		Triolang and occ		DC resistance change	Within ±10%		
22	Terminal Strength	Per AEC-Q200-006 A force of 17.7N for 60s	Murata Deviation Request : 10N/5s No defect				

8. Specification of Packaging

8.1 Appearance and Dimensions of paper tape (8mm-wide).



8.2 Specification of Taping

- (1) Packing quantity (standard quantity)
 - 4,000 pcs. / reel
- (2) Packing Method

Products shall be packed in the cavity of the base tape and sealed by top tape and bottom tape.

- (3) Sprocket hole
 - The sprocket holes are to the right as the tape is pulled toward the user.
- (4) Spliced point
 - Base tape and Top tape has no spliced point.
- (5) Missing components number

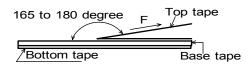
Missing components number within 0.1 % of the number per reel or 1 pc., whichever is greater, and are not continuous. The Specified quantity per reel is kept.

8.3 Pull Strength

Top tape	5N min.
Bottom tape	SIN IIIIII.

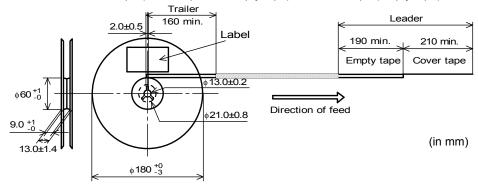
8.4 Peeling off force of cover tape

	p
Speed of Peeling off	300mm/min
Peeling off force	0.1N to 0.6N (minimum value is typical)



8.5 Dimensions of Leader-tape, Trailer and Reel

There shall be leader-tape (cover tape and empty tape) and trailer-tape (empty tape) as follows.



8.6 Marking for reel

Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity etc · · ·

*1) <Expression of Inspection No.> $\frac{\Box \Box}{(1)} \frac{OOOO}{(2)} \frac{xxx}{(3)}$

(1) Factory Code

(2) Date First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D

Third, Fourth digit : Day

(3) Serial No.

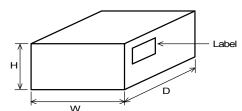
*2) <Expression of RoHS marking> ROHS – \underline{Y} ($\underline{\triangle}$) (1) (2)

- (1) RoHS regulation conformity
- (2) MURATA classification number

8.7 Marking for Outside package (corrugated paper box)

Customer name, Purchasing order number, Customer part number, MURATA part number, RoHS Marking (*2) , Quantity, etc \cdots

8.8 Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity
W	D	Н	in Outer Case (Reel)
186	186	93	5

 Above Outer Case size is typical. It depends on a quantity of an order.

9. A Caution

9.1 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (6) Transportation equipment (trains, ships, etc.)
- (2) Aerospace equipment
- (7) Traffic signal equipment
- (3) Undersea equipment
- (8) Disaster prevention / crime prevention equipment
- (4) Power plant control equipment
- (9) Data-processing equipment
- (5) Medical equipment
- (10) Applications of similar complexity and /or reliability requirements to the applications listed in the above

9.2 Caution (Rating)

Do not exceed maximum rated current of the product. Thermal stress may be transmitted to the product and short / open circuit of the product or falling off the product may be occurred.

9.3 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.



10. Notice

Products can only be soldered with reflow.

This product is designed for solder mounting.

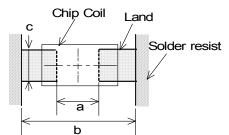
Please consult us in advance for applying other mounting method such as conductive adhesive.

10.1 Land pattern designing

Recommended land patterns for reflow soldering are as follows:

These have been designed for Electric characteristics and solderability.

Please follow the recommended patterns. Otherwise, their performance which includes electrical performance or solderability may be affected, or result to "position shift" in soldering process.



а	0.86
b	2.00
С	1.15
	(in mm)

10.2 Flux, Solder

· Use rosin-based flux.

Includes middle activator equivalent to 0.06(wt)% to 0.1(wt)% Chlorine.

Don't use highly acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).

Don't use water-soluble flux.

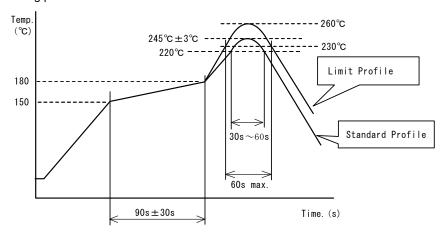
- ·Use Sn-3.0Ag-0.5Cu solder.
- Standard thickness of solder paste : 100μ m to 150μ m.

10.3 Reflow soldering conditions

 Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

- Standard soldering profile and the limit soldering profile is as follows.
 The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.
- · Reflow soldering profile



	Standard Profile	Limit Profile	
Pre-heating	150°C~180°C 、90s±30s		
Heating	above 220°C, 30s~60s	above 230°C, 60s max.	
Peak temperature	245°C±3°C	260°C,10s	
Cycle of reflow	2 times	2 times	

10.4 Reworking with soldering iron

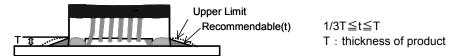
The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C,1 min
Tip temperature	350°C max.
Soldering iron output	80W max.
Tip diameter	φ3mm max.
Soldering time	3(+1,-0)s
Time	2 times

Note: Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the products due to the thermal shock.

10.5 Solder Volume

- Solder shall be used not to be exceeded the upper limits as shown below.
- Accordingly increasing the solder volume, the mechanical stress to Chip is also increased.
 Exceeding solder volume may cause the failure of mechanical or electrical performance.

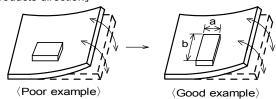


10.6 Product's location

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress due to warping the board.

[Products direction]

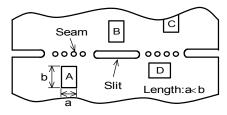


Products shall be located in the sideways direction (Length:a < b) to the mechanical stress.

(2) Components location on P.C.B. separation.

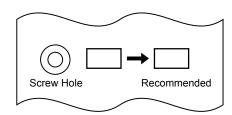
It is effective to implement the following measures, to reduce stress in separating the board. It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes
When a component is mounted near a screw hole,
it may be affected by the board deflection that occurs
during the tightening of the screw. Mount the component
in a position as far away from the screw holes as possible.





10.7 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max. (40°C max for IPA)
- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20 W / I max. Frequency: 28kHz to 40kHz Time: 5 min max.

- (3) Cleaner
 - Alcohol type cleaner Isopropyl alcohol (IPA)
 - 2. Aqueous agent

PINE ALPHA ST-100S

- (4) There shall be no residual flux and residual cleaner after cleaning.
 - In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning Please contact us.

10.8 Resin coating

The inductance value may change due to high cure-stress of resin to be used for coating/molding products.

An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit.

So, please pay your careful attention when you select resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

10.9 Caution for use

- Sharp material such as a pair of tweezers or other material such as bristles of cleaning brush, shall not be touched to the winding portion to prevent the breaking of wire.
- · Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core.

10.10 Notice of product handling at mounting

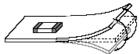
In some mounting machines, when picking up components support pin pushes up the components from the bottom of base tape. In this case, please remove the support pin. The support pin may damage the components and break wire. In rare case, the laser recognition can not recognize this component. Please contact us when you use laser recognition. (There is no problem with the permeation and reflection type.)

10.11 Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.

Bending



Twisting



10.12 Storage and Handing Requirements

(1) Storage period

Use the products within 12 months after delivered.

Solderability should be checked if this period is exceeded.

- (2) Storage conditions
 - Products should be stored in the warehouse on the following conditions.

Temperature : -10°C to 40°C

Humidity : 15% to 85% relative humidity No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should not be stored on bulk packaging condition to prevent the chipping of the core and the breaking of winding wire caused by the collision between the products.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- (3) Handling Condition

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.



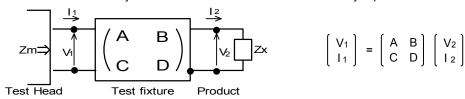
11. **Note**

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice.

 Please approve our product specifications or transact the approval sheet for product specifications before ordering.

<Electrical Performance:Measuring Method of Inductance / Q> -

(1) Residual elements and stray elements of test fixture can be described by F-parameter shown in following.



(2) The impedance of chip coil Zx and measured value Zm can be described by input/output current/voltage.

$$Zm = \frac{V_1}{I_1}$$
, $Zx = \frac{V_2}{I_2}$

(3) Thus, the relation between Zx and Zm is following;

$$Zx=\alpha \ \ \frac{Zm-\beta}{1-Zm\Gamma} \qquad \qquad \text{where, } \alpha=D\ /\ A=1 \\ \beta=B\ /\ D=Zsm-(1-Yom\ Zsm)Zss \\ \Gamma=C\ /\ A=Yom$$

Zsm: measured impedance of short chip
Zss: residual impedance of short chip (0.771nH)
Yom: measured admittance when opening the fixture

(4) Lx and Qx shall be calculated with the following equation.

$$Lx = \frac{Im(Zx)}{2\pi f}, \quad Qx = \frac{Im(Zx)}{Re(Zx)} \qquad \begin{array}{c} Lx: \text{ Inductance of chip coil} \\ Qx: Q \text{ of chip coil} \\ f: \text{ Measuring frequency} \end{array}$$